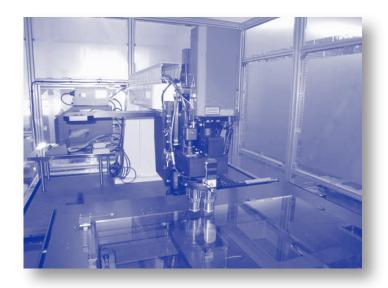
SEIWA Laser Autofocus System



Seiwa's laser autofocus system combines advanced optics and system customization to provide fast and accurate focusing of products for image processing and other vision applications. The laser autofocus system is a motorized vision stage control system that is integrated with through-the-lens measurement and a non-contact optical sensor for dynamic focusing, stepper motors for precision control, microscopic objective lenses for high resolution and a user interface application which offers options and control for the user. The laser autofocus is ideal for a wide range of applications such as semiconductor wafer and device inspection, flat panel display inspection, and many other automated inspection and vision based applications. Here are advantages in using Seiwa's laser autofocus:

Here are advantages in using Seiwa's laser autofocus:

Advantages	Features
Faster autofocus and large improvement in productivity(sample rate max: 5kHz)	Sample rate is 10 times faster than conventional, video autofocus
Greater focus accuracy in a wide variety of samples	Users have option to select laser angle: 45 or 90 degree angle. 45 degree angle helps prevent laser line from falling into line of pattern.
High-definition image input in wide variety of sample colors	Users have option to select from two laser wavelengths (670nm and 785nm). Compatible with mono and color cameras as well as high definition line scan cameras.
Complete turnkey solution	Seiwa's complete turnkey solution includes all optics and operating software.

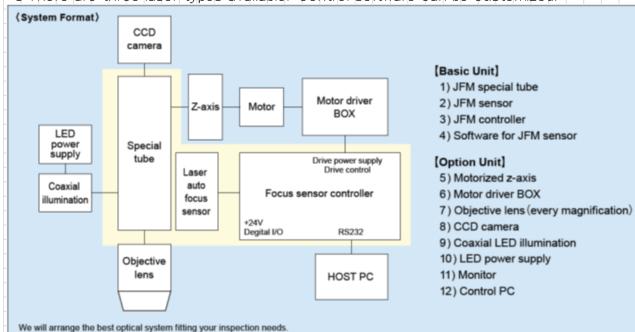


Basic Configuration

Laser autofocus unit with DIC systems

Specifications

OThere are three laser types available. Control software can be customized.



<Laser Specification>

Model No. LAF3-C, LAF4-C, LAF4-C785

Laser Type Semiconductor Laser

Output wavelength 670nm (LAF3-C, LAF4-C), 785nm(LAF4-C785)

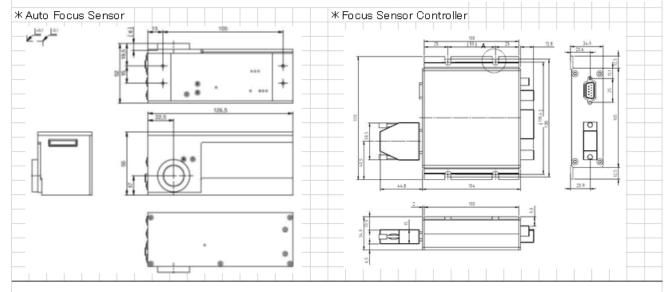
Safety Design Class 3B

Sample rate 5kHz at maximum

Focus positioning time External trigger type: 0.2 sec

Tracking Type : 0 sec

Model	Wave length	Laser beam shape
LAF3-C	670nm	Straight
LAF4-C	670nm	45 degree
LAF4-C785	785nm	45 degree

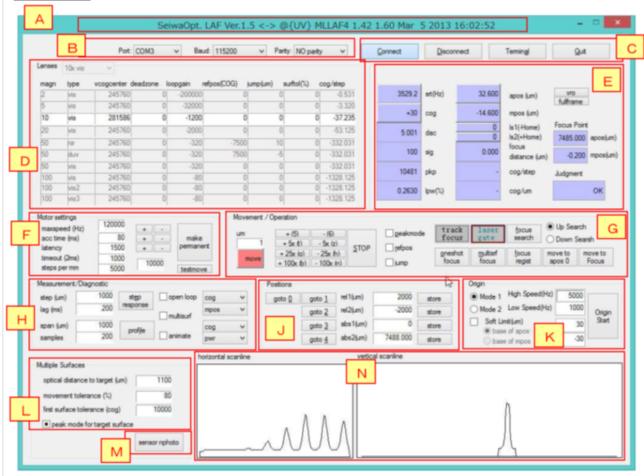




Software

Laser auto focus unit with DIC systems





Main screen consists of the following parts:

A:Software Version

B:Communication settings

C:Communication connection status

D:Lens selection

E:Status displaying

F:Motorsettings

G:Movement and Operation

H: Measurement and Diagnostics

J:Coordinate Positioning

K:Origin Return

L:MultiSurface

M:Sensor Photo

N:Scan Line Display (horizontal/vertical

scanline)

PC Requirements

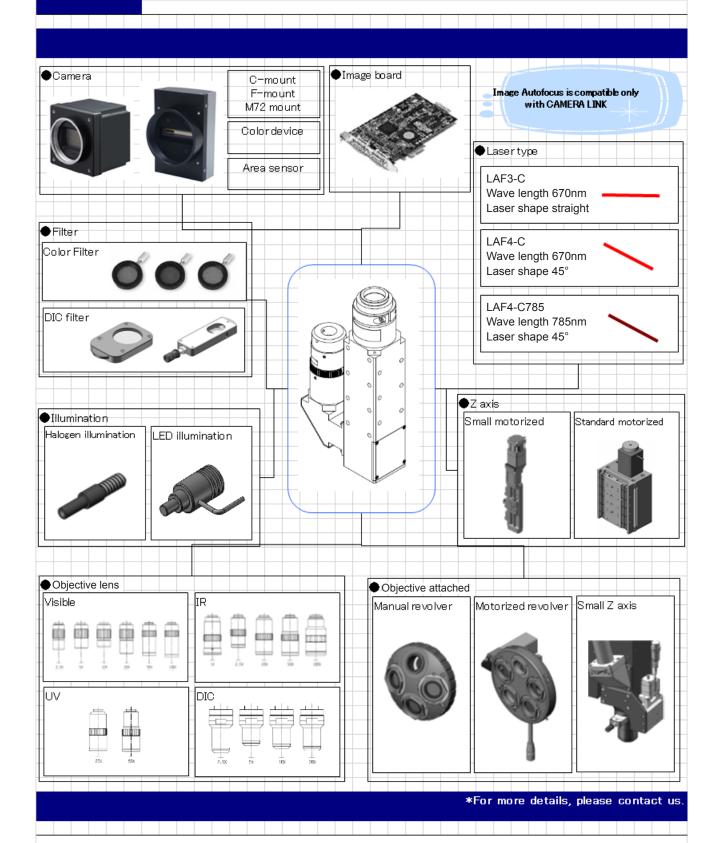
OS Windows XP
Windows 7(32bit & 64bit)
Windows 8(64bit)
CPU Intel Core i5 or better
Memory More than 2GB
HDD More than 120GB
Interface RS232C port or Converte

RS232C port or Converter using IC manufactured by FDTI

Recommended: LINEEYE Co., Ltd LE-US232B



System Diagram



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